



**THE DATASHEET OF
PBHV9215Z**





PBHV9215Z

150 V, 2 A PNP high-voltage low V_{CEsat} transistor

17 July 2023

Product data sheet

1. General description

PNP high-voltage low V_{CEsat} transistor in a medium power SOT223 (SC-73) Surface-Mounted Device (SMD) plastic package.

NPN complement: PBHV8215Z

2. Features and benefits

- High voltage
- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain h_{FE} at high I_C
- Medium power SMD plastic package
- AEC-Q101 qualified

3. Applications

- LED driver for LED chain module
- LCD backlighting
- Automotive motor management
- Switch Mode Power Supply (SMPS)

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CEO}	collector-emitter voltage	open base	-	-	-150	V
I_C	collector current		-	-	-2	A
h_{FE}	DC current gain	$V_{CE} = -10$ V; $I_C = -100$ mA; pulsed; $t_p \leq 300$ μ s; $\delta = 0.02$; $T_{amb} = 25$ °C	100	180	-	

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base	<p>SC-73 (SOT223)</p>	<p>sym028</p>
2	C	collector		
3	E	emitter		
4	C	collector		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PBHV9215Z	SC-73	plastic, surface-mounted package with increased heatsink; 4 leads; 2.3 mm pitch; 6.5 mm x 3.5 mm x 1.65 mm body	SOT223

7. Marking

Table 4. Marking codes

Type number	Marking code
PBHV9215Z	V9215Z

8. Limiting values

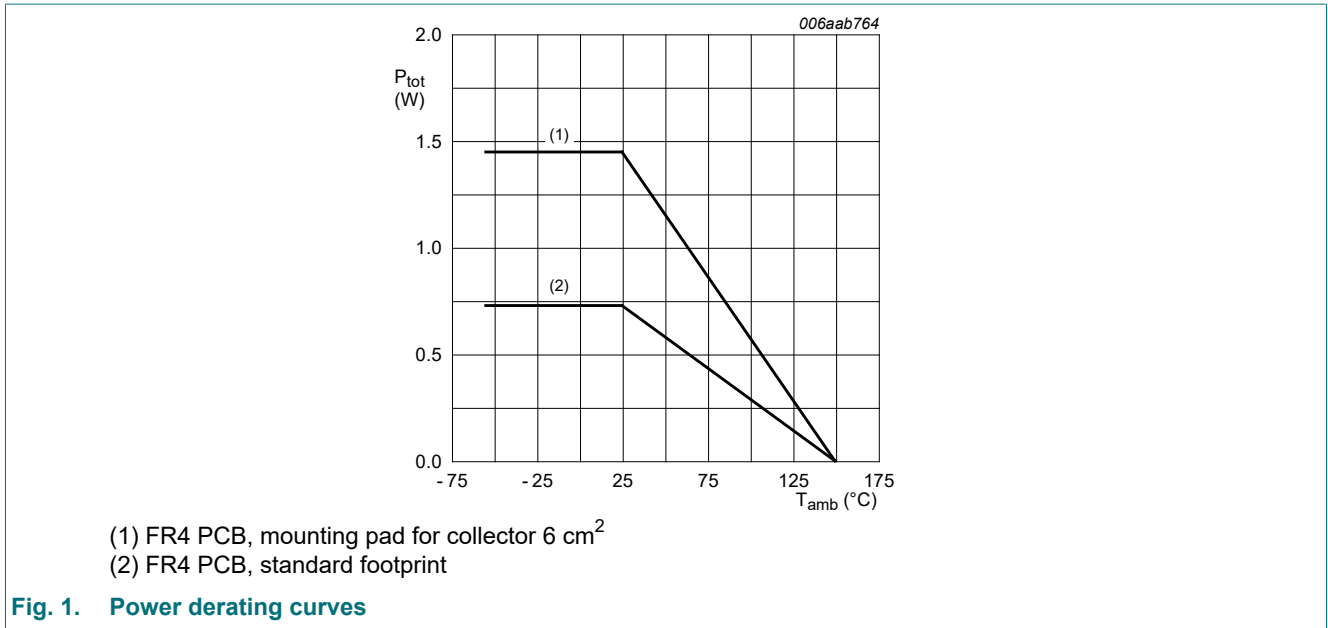
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter		-	-200	V
V_{CEO}	collector-emitter voltage	open base		-	-150	V
V_{EBO}	emitter-base voltage	open collector		-	-6	V
I_C	collector current			-	-2	A
I_{CM}	peak collector current	single pulse; $t_p \leq 1$ ms		-	-4	A
I_{BM}	peak base current			-	-500	mA
P_{tot}	total power dissipation	$T_{amb} \leq 25$ °C	[1]	-	0.73	W
			[2]	-	1.45	W
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².

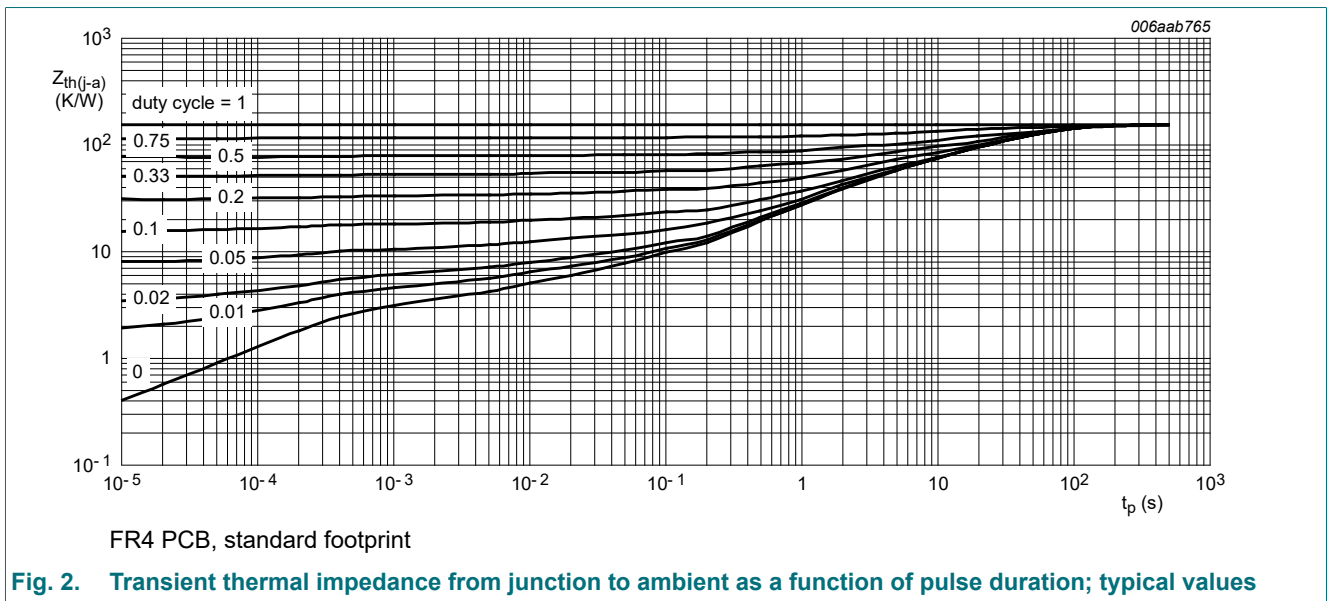


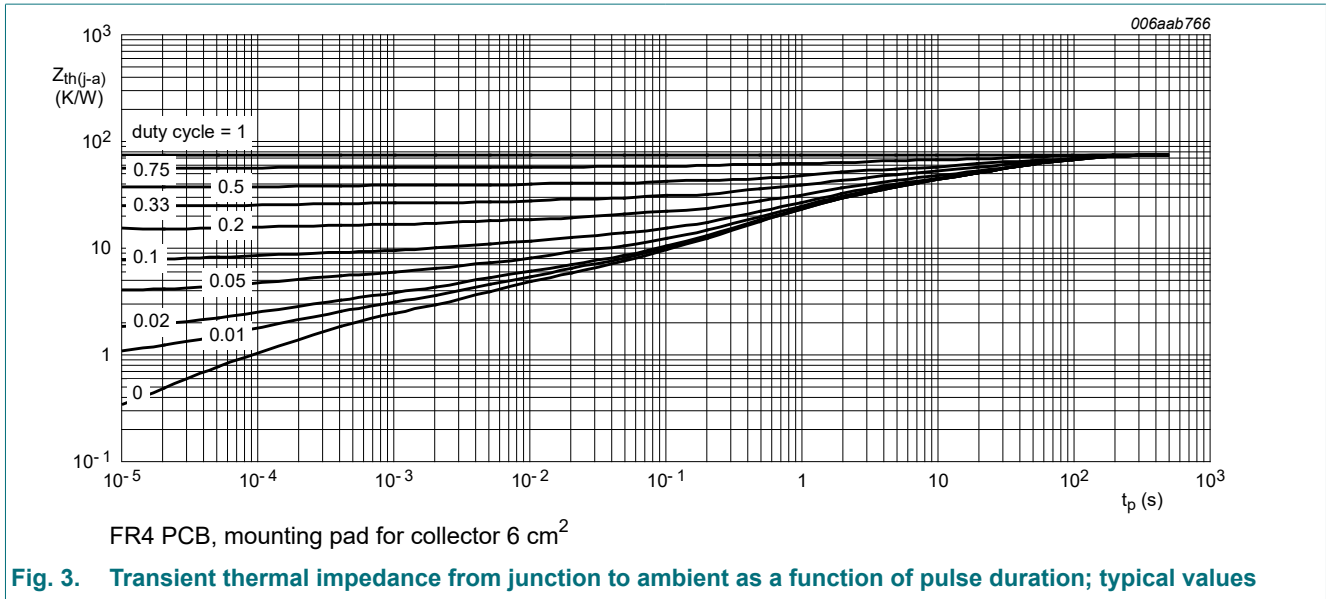
9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	-	170	K/W
			[2]	-	-	85	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	15	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².





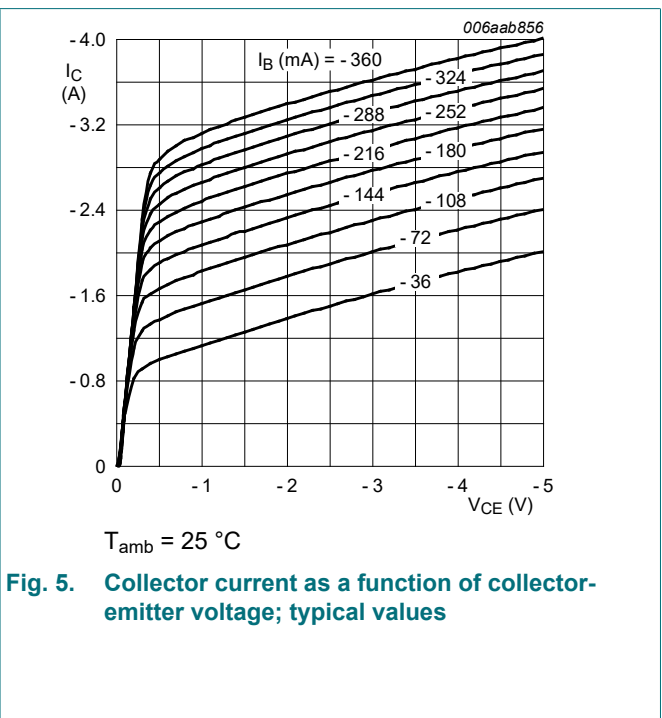
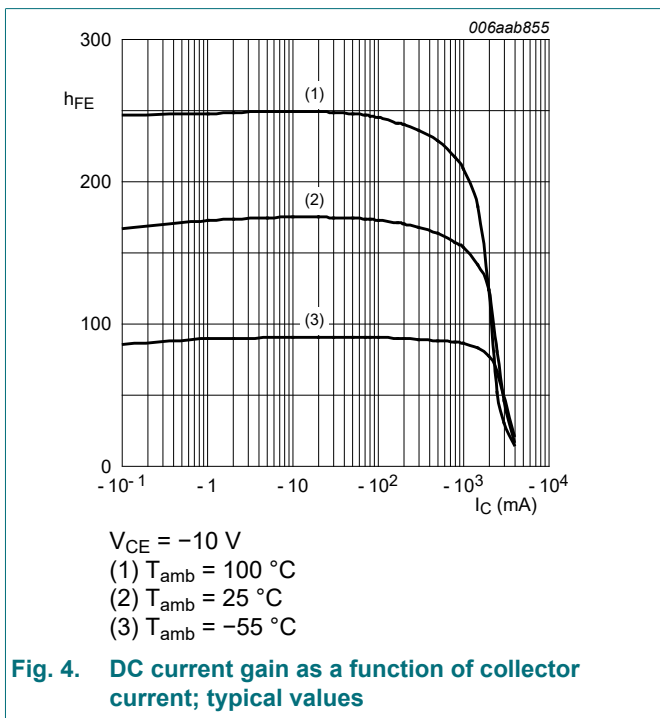
10. Characteristics

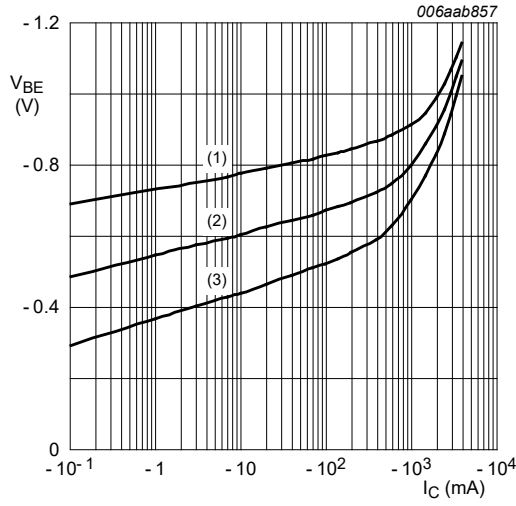
Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I _{CB0}	collector-base cut-off current	V _{CB} = -120 V; I _E = 0 A; T _{amb} = 25 °C	-	-	-100	nA
		V _{CB} = -120 V; I _E = 0 A; T _j = 150 °C	-	-	-10	μA
I _{EBO}	emitter-base cut-off current	V _{EB} = -4 V; I _C = 0 A; T _{amb} = 25 °C	-	-	-100	nA
I _{CES}	collector-emitter cut-off current	V _{CE} = -120 V; V _{BE} = 0 V; T _{amb} = 25 °C	-	-	-100	nA
h _{FE}	DC current gain	V _{CE} = -10 V; I _C = -100 mA; pulsed; t _p ≤ 300 μs; δ = 0.02; T _{amb} = 25 °C	100	180	-	
		V _{CE} = -10 V; I _C = -1 A; pulsed; t _p ≤ 300 μs; δ = 0.02; T _{amb} = 25 °C	80	155	-	
		V _{CE} = -10 V; I _C = -1.5 A; pulsed; t _p ≤ 300 μs; δ = 0.02; T _{amb} = 25 °C	70	140	-	
		V _{CE} = -10 V; I _C = -2 A; pulsed; t _p ≤ 300 μs; δ = 0.02; T _{amb} = 25 °C	60	120	-	
V _{CEsat}	collector-emitter saturation voltage	I _C = -100 mA; I _B = -20 mA; pulsed; t _p ≤ 300 μs; δ = 0.02; T _{amb} = 25 °C	-	-25	-50	mV
		I _C = -1 A; I _B = -200 mA; pulsed; t _p ≤ 300 μs; δ = 0.02; T _{amb} = 25 °C	-	-110	-190	mV
		I _C = -1.5 A; I _B = -300 mA; pulsed; t _p ≤ 300 μs; δ = 0.02; T _{amb} = 25 °C	-	-155	-270	mV
		I _C = -2 A; I _B = -400 mA; pulsed; t _p ≤ 300 μs; δ = 0.02; T _{amb} = 25 °C	-	-200	-350	mV
R _{CEsat}	collector-emitter saturation resistance	I _C = -2 A; I _B = -400 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _{amb} = 25 °C	-	100	175	mΩ
V _{BEsat}	base-emitter saturation voltage		-	-1	-1.15	V

150 V, 2 A PNP high-voltage low VCEsat transistor

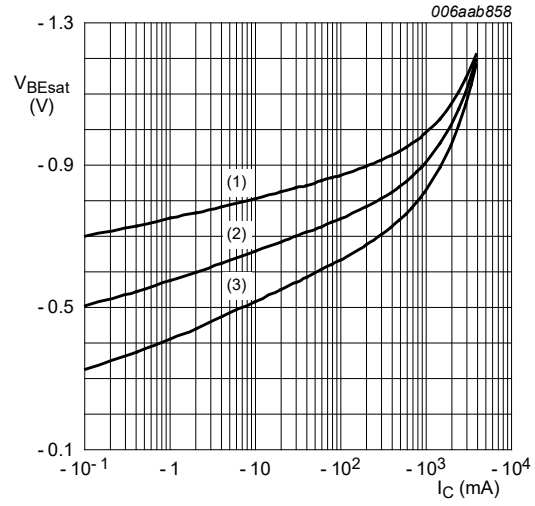
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t_d	delay time	$V_{CC} = -6\text{ V}; I_C = -0.5\text{ A}; I_{B\text{on}} = -0.1\text{ A}; I_{B\text{off}} = 0.1\text{ A}; T_{\text{amb}} = 25\text{ }^\circ\text{C}$	-	20	-	ns
t_r	rise time		-	105	-	ns
t_{on}	turn-on time		-	125	-	ns
t_s	storage time		-	875	-	ns
t_f	fall time		-	150	-	ns
t_{off}	turn-off time		-	1025	-	ns
f_T	transition frequency	$V_{CE} = -10\text{ V}; I_C = -10\text{ mA}; f = 100\text{ MHz}; T_{\text{amb}} = 25\text{ }^\circ\text{C}$	-	35	-	MHz
C_c	collector capacitance	$V_{CB} = -20\text{ V}; I_E = 0\text{ A}; i_e = 0\text{ A}; f = 1\text{ MHz}; T_{\text{amb}} = 25\text{ }^\circ\text{C}$	-	30	-	pF
C_e	emitter capacitance	$V_{EB} = -0.5\text{ V}; I_C = 0\text{ A}; i_c = 0\text{ A}; f = 1\text{ MHz}; T_{\text{amb}} = 25\text{ }^\circ\text{C}$	-	530	-	pF





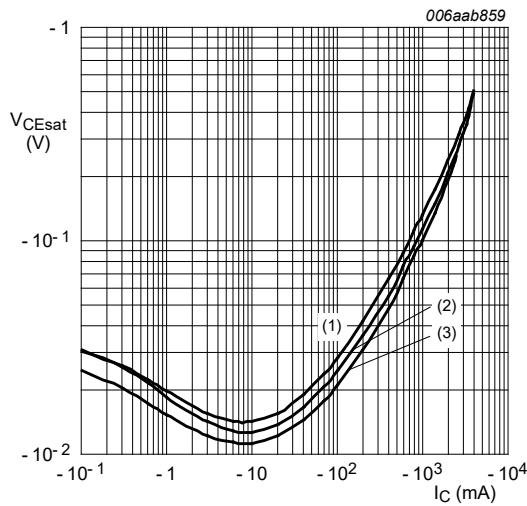
$V_{CE} = -10 \text{ V}$
 (1) $T_{amb} = -55 \text{ }^\circ\text{C}$
 (2) $T_{amb} = 25 \text{ }^\circ\text{C}$
 (3) $T_{amb} = 100 \text{ }^\circ\text{C}$

Fig. 6. Base-emitter voltage as a function of collector current; typical values



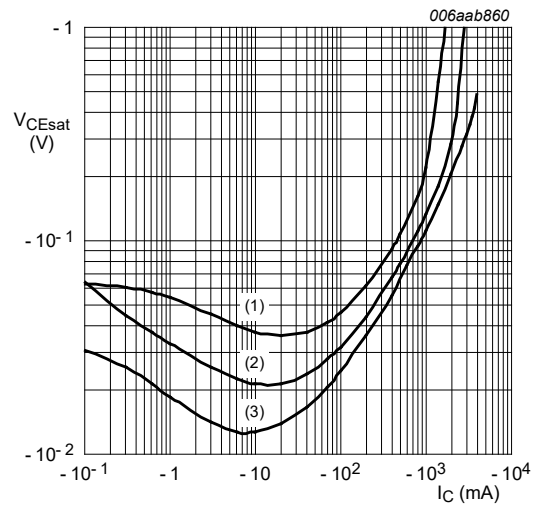
$I_C/I_B = 5$
 (1) $T_{amb} = -55 \text{ }^\circ\text{C}$
 (2) $T_{amb} = 25 \text{ }^\circ\text{C}$
 (3) $T_{amb} = 100 \text{ }^\circ\text{C}$

Fig. 7. Base-emitter saturation voltage as a function of collector current; typical values



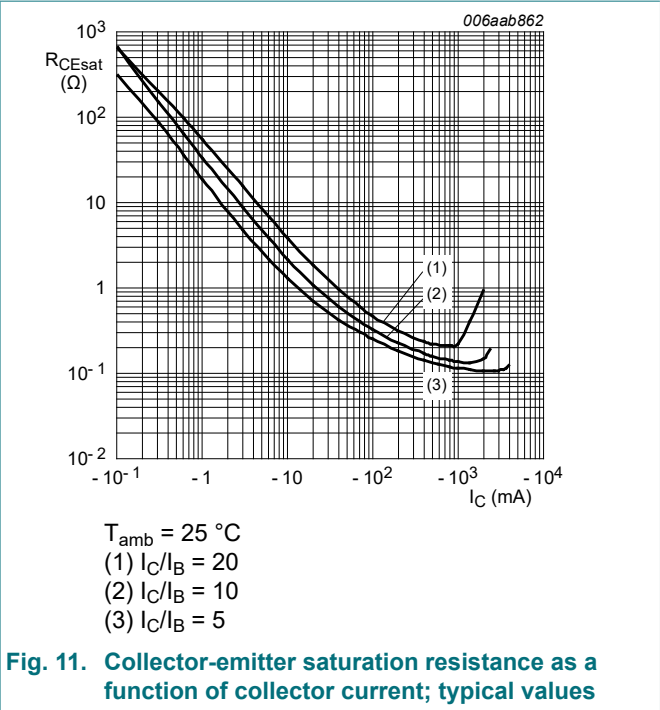
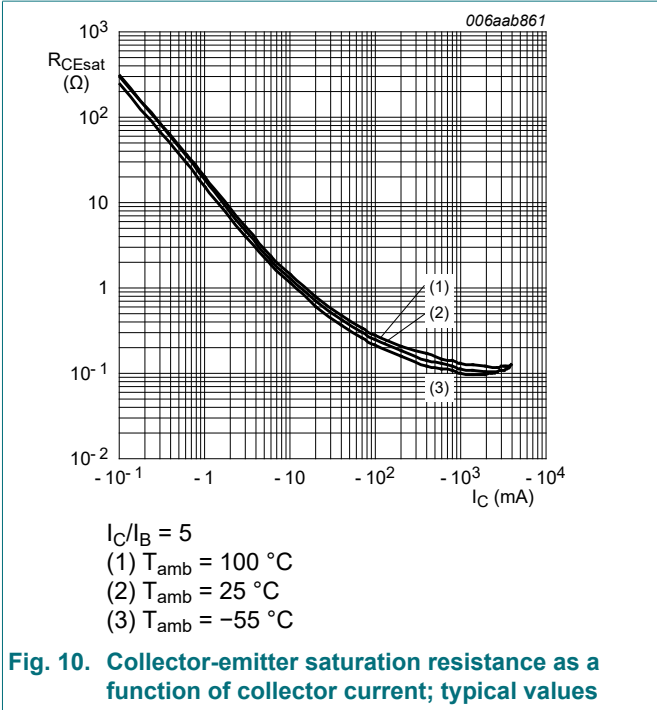
$I_C/I_B = 5$
 (1) $T_{amb} = 100 \text{ }^\circ\text{C}$
 (2) $T_{amb} = 25 \text{ }^\circ\text{C}$
 (3) $T_{amb} = -55 \text{ }^\circ\text{C}$

Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values

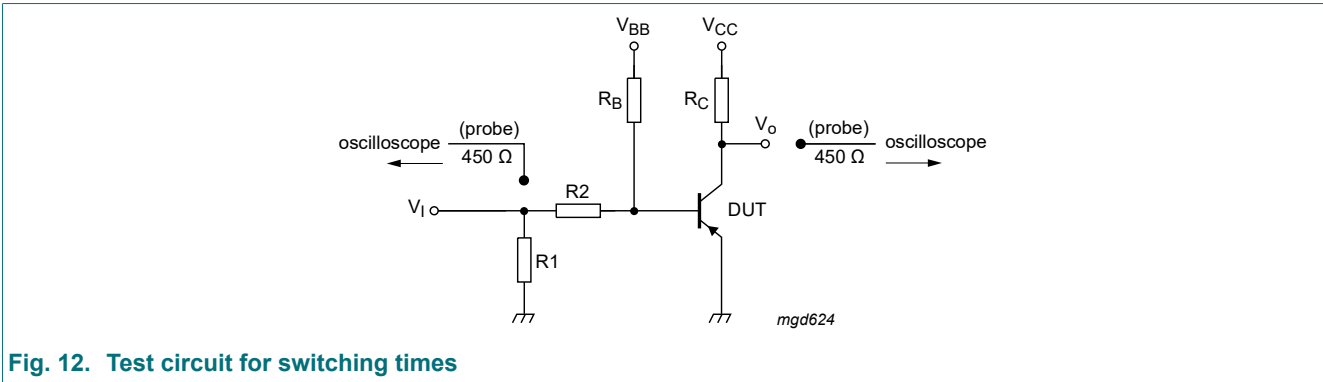


$T_{amb} = 25 \text{ }^\circ\text{C}$
 (1) $I_C/I_B = 20$
 (2) $I_C/I_B = 10$
 (3) $I_C/I_B = 5$

Fig. 9. Collector-emitter saturation voltage as a function of collector current; typical values



11. Test information



Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

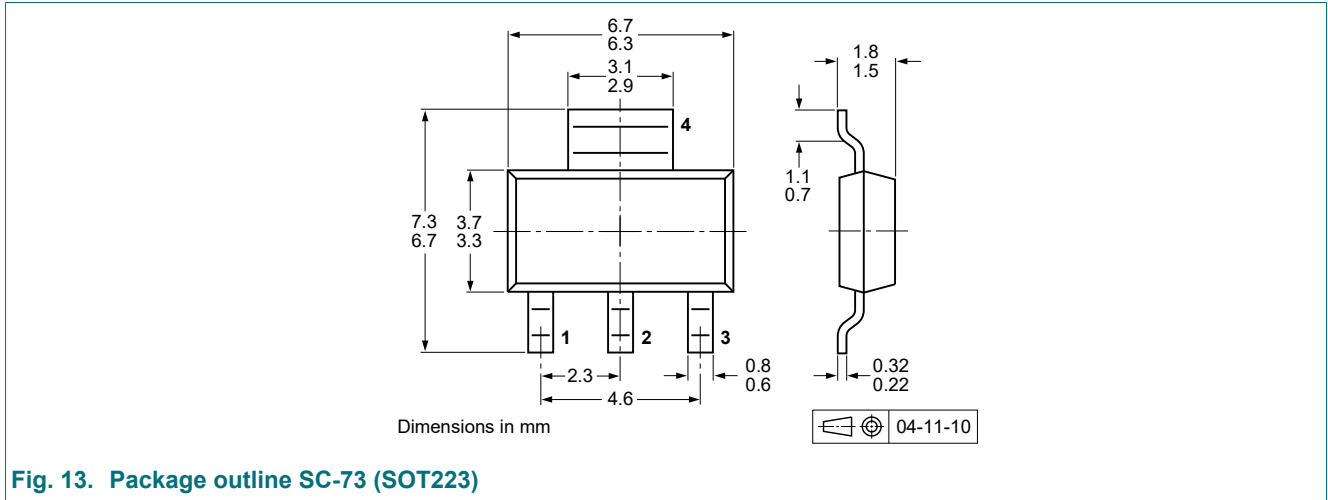


Fig. 13. Package outline SC-73 (SOT223)

13. Soldering

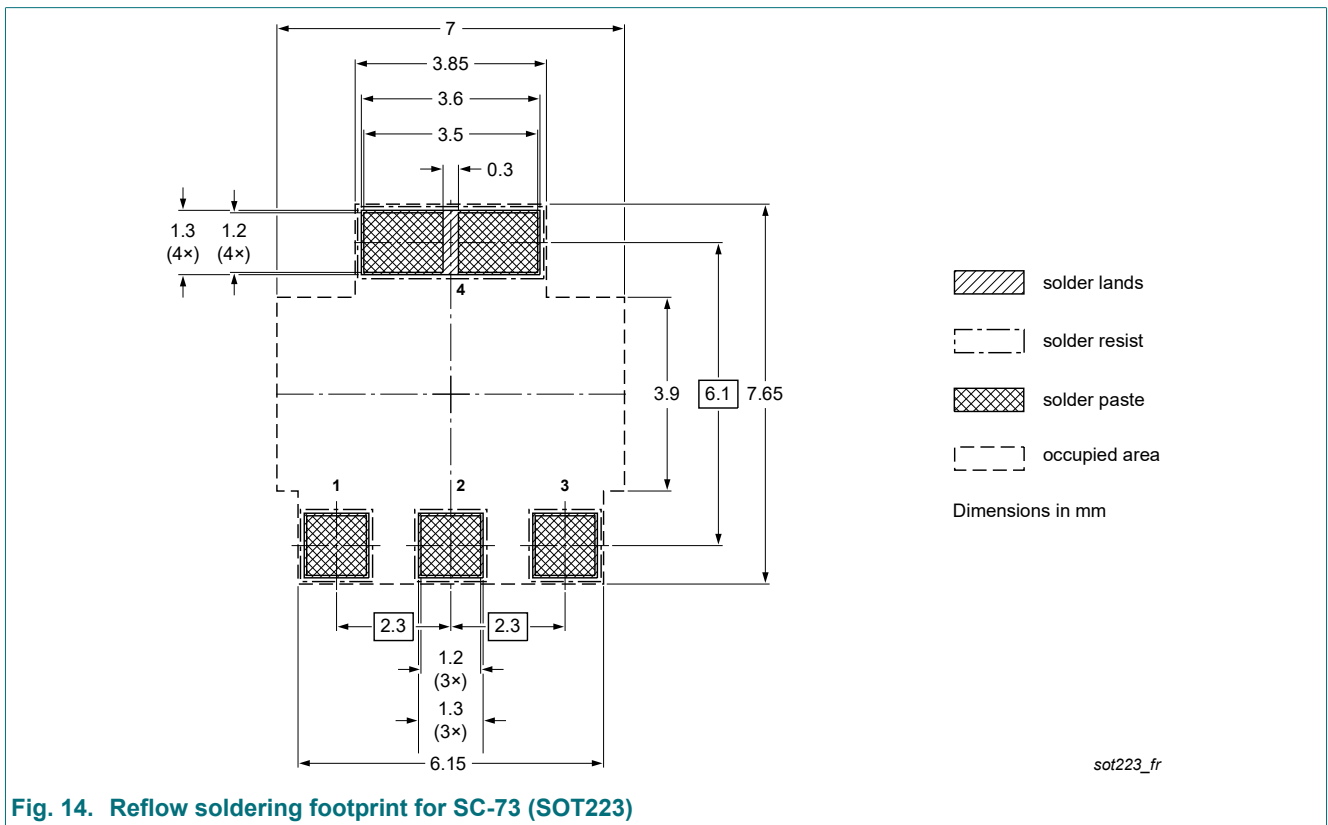


Fig. 14. Reflow soldering footprint for SC-73 (SOT223)

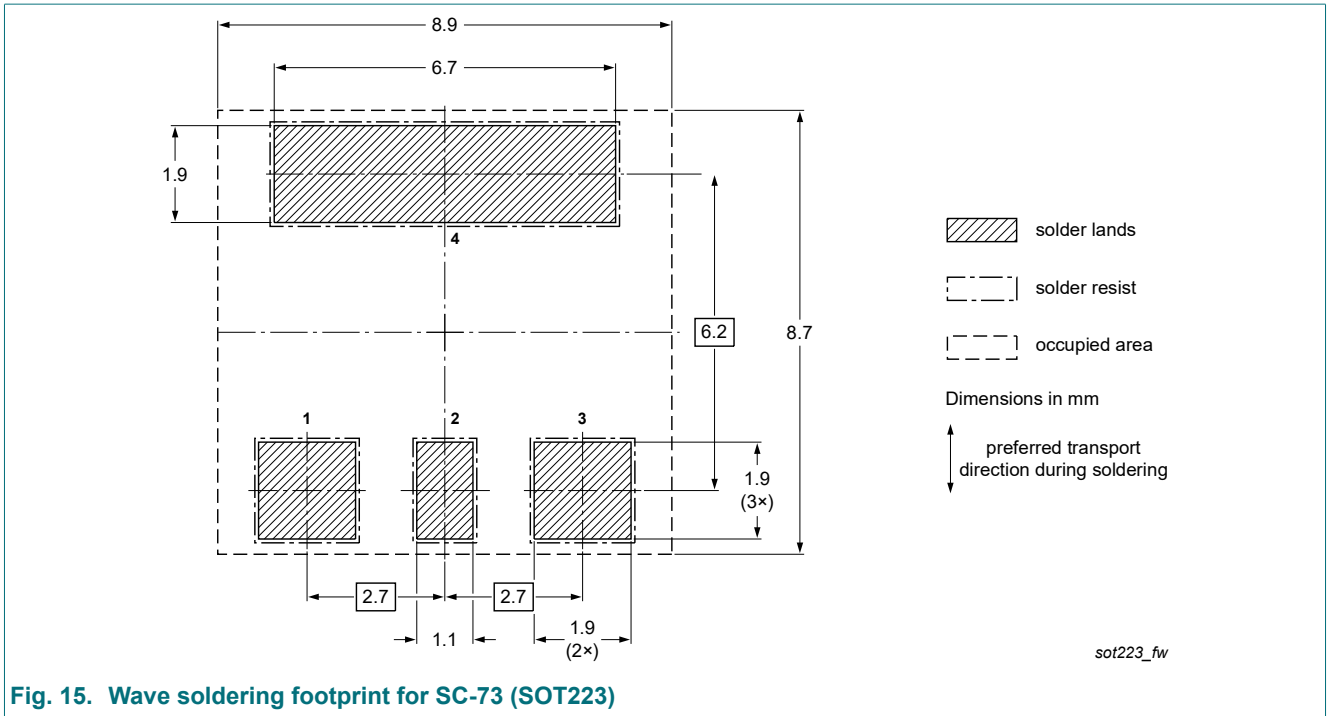


Fig. 15. Wave soldering footprint for SC-73 (SOT223)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PBHV9215Z v.2	20230717	Product data sheet	-	PBHV9215Z_1
Modifications:	<ul style="list-style-type: none">• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.• Legal texts have been adapted to the new company name where appropriate.• Section "Packing information" removed.			
PBHV9215Z_1	20091211	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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